74AUP2G157

Low-power 2-input multiplexer

Rev. 7 — 18 January 2013 Product data sheet

1. General description

The 74AUP2G157 is a single 2-input multiplexer which select data from two data inputs (I0 and I1) under control of a common data select input (S). The state of the common data select input determines the particular register from which the data comes. The output (Y, $\overline{Y}$) presents the selected data in the true (non-inverted) and complement form. The enable input ($\overline{E}$) is active LOW. When $\overline{E}$ is HIGH, the output Y is forced LOW and the output $\overline{Y}$ is forced HIGH regardless of all other input conditions.

Schmitt trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V. This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial power-down applications using I_{OFF}.
The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

2. Features and benefits

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
  - JESD8-12 (0.8 V to 1.3 V)
  - JESD8-11 (0.9 V to 1.65 V)
  - JESD8-7 (1.2 V to 1.95 V)
  - JESD8-5 (1.8 V to 2.7 V)
  - JESD8-B (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F Class 3A exceeds 5000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM JESD22-C101E exceeds 1000 V
- Low static power consumption; I_{CC} = 0.9 μA (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from −40 °C to +85 °C and −40 °C to +125 °C

3. Ordering information

Table 1. Ordering information

Type number	Package			
	Temperature range	Name	Description	Version
74AUP2G157DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1
74AUP2G157GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm	SOT833-1
74AUP2G157GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1 × 0.5 mm	SOT1089
74AUP2G157GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 3 × 2 × 0.5 mm	SOT996-2
74AUP2G157GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 × 1.6 × 0.5 mm	SOT902-2
74AUP2G157GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.2 × 1.0 × 0.35 mm	SOT1116
74AUP2G157GS	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 × 1.0 × 0.35 mm	SOT1203

4. Marking

Table 2. Marking codes

Type number	Marking code[1]
74AUP2G157DC	a2P
74AUP2G157GT	a2P
74AUP2G157GF	aP
74AUP2G157GD	a2P
74AUP2G157GM	a2P
74AUP2G157GN	aP
74AUP2G157GS	aP

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

5. Functional diagram

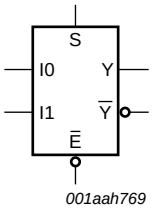


Fig 1. Logic symbol

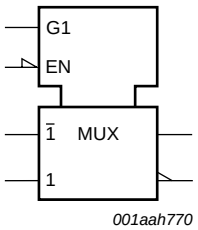


Fig 2. IEC logic symbol

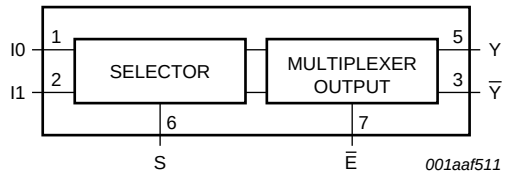


Fig 3. Logic diagram

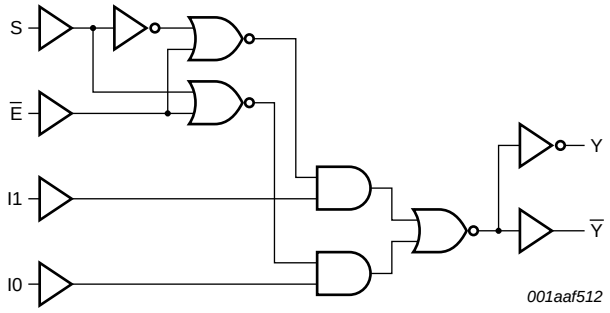


Fig 4. Functional diagram

6. Pinning information

6.1 Pinning

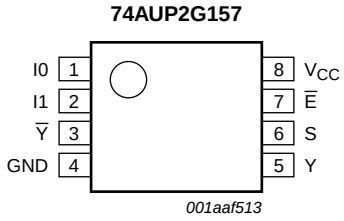
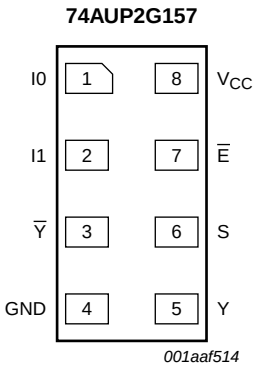
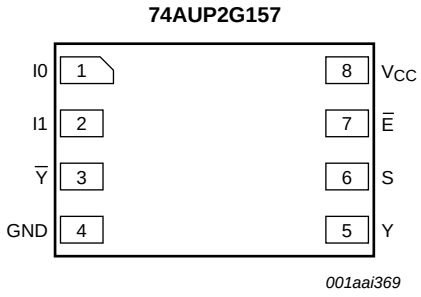


Fig 5. Pin configuration SOT765-1



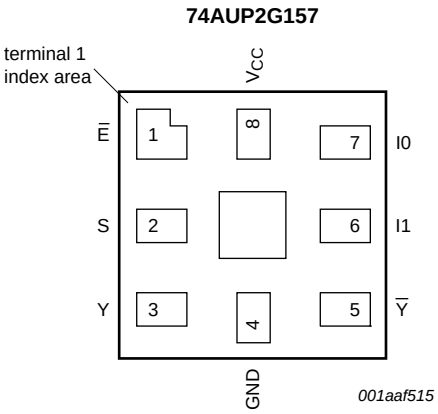
Transparent top view

Fig 6. Pin configuration SOT833-1, SOT1089, SOT1116 and SOT1203



Transparent top view

Fig 7. Pin configuration SOT996-2



Transparent top view

Fig 8. Pin configuration SOT902-2

6.2 Pin description

Table 3. Pin description

Symbol	Pin		Description
	SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
I0	1	7	data input from source 0
I1	2	6	data input from source 1
$\overline{Y}$	3	5	complement multiplexer output
GND	4	4	ground (0 V)
Y	5	3	true multiplexer output
S	6	2	data select input
$\overline{E}$	7	1	enable input (active LOW)
V_{CC}	8	8	supply voltage

7. Functional description

Table 4. Function table[1]

Input				Output	
$\overline{E}$	S	I0	I1	Y	$\overline{Y}$
H	X	X	X	L	H
L	L	L	X	L	H
L	L	H	X	H	L
L	H	X	L	L	H
L	H	X	H	H	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{CC}	supply voltage			−0.5	+4.6	V
I_{IK}	input clamping current	$V_I < 0$ V		−50	-	mA
V_I	input voltage		[1]	−0.5	+4.6	V
I_{OK}	output clamping current	$V_O < 0$ V		−50	-	mA
V_O	output voltage	Active mode and Power-down mode	[1]	−0.5	+4.6	V
I_O	output current	V_O = 0 V to V_{CC}		-	±20	mA
I_{CC}	supply current			-	50	mA
I_{GND}	ground current			−50	-	mA
T_{stg}	storage temperature			−65	+150	°C
P_{tot}	total power dissipation	T_{amb} = −40 °C to +125 °C	[2]	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.
For XSON8 and XQFN8 packages: above 118 °C the value of P_{tot} derates linearly with 7.8 mW/K.

9. Recommended operating conditions

Table 6. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		0.8	3.6	V
V_I	input voltage		0	3.6	V
V_O	output voltage	Active mode	0	V_{CC}	V
		Power-down mode; V_{CC} = 0 V	0	3.6	V
T_{amb}	ambient temperature		−40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 0.8 V to 3.6 V	0	200	ns/V

10. Static characteristics

Table 7. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_{amb} = 25 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V

Table 7. Static characteristics *…continued*

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = –20 μA; V_{CC} = 0.8 V to 3.6 V	V_{CC} – 0.1	-	-	V
		I_O = –1.1 mA; V_{CC} = 1.1 V	0.75 × V_{CC}	-	-	V
		I_O = –1.7 mA; V_{CC} = 1.4 V	1.11	-	-	V
		I_O = –1.9 mA; V_{CC} = 1.65 V	1.32	-	-	V
		I_O = –2.3 mA; V_{CC} = 2.3 V	2.05	-	-	V
		I_O = –3.1 mA; V_{CC} = 2.3 V	1.9	-	-	V
		I_O = –2.7 mA; V_{CC} = 3.0 V	2.72	-	-	V
		I_O = –4.0 mA; V_{CC} = 3.0 V	2.6	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		I_O = 20 μA; V_{CC} = 0.8 V to 3.6 V	-	-	0.1	V
		I_O = 1.1 mA; V_{CC} = 1.1 V	-	-	0.3 × V_{CC}	V
		I_O = 1.7 mA; V_{CC} = 1.4 V	-	-	0.31	V
		I_O = 1.9 mA; V_{CC} = 1.65 V	-	-	0.31	V
		I_O = 2.3 mA; V_{CC} = 2.3 V	-	-	0.31	V
		I_O = 3.1 mA; V_{CC} = 2.3 V	-	-	0.44	V
		I_O = 2.7 mA; V_{CC} = 3.0 V	-	-	0.31	V
		I_O = 4.0 mA; V_{CC} = 3.0 V	-	-	0.44	V
I_I	input leakage current	V_I = GND to 3.6 V; V_{CC} = 0 V to 3.6 V	-	-	±0.1	μA
I_{OFF}	power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V	-	-	±0.2	μA
ΔI_{OFF}	additional power-off leakage current	V_I or V_O = 0 V to 3.6 V; V_{CC} = 0 V to 0.2 V	-	-	±0.2	μA
I_{CC}	supply current	V_I = GND or V_{CC}; I_O = 0 A; V_{CC} = 0.8 V to 3.6 V	-	-	0.5	μA
ΔI_{CC}	additional supply current	$V_I = V_{CC}$ – 0.6 V; I_O = 0 A; V_{CC} = 3.3 V [1]	-	-	40	μA
C_I	input capacitance	V_{CC} = 0 V to 3.6 V; V_I = GND or V_{CC}	-	0.6	-	pF
C_O	output capacitance	V_O = GND; V_{CC} = 0 V	-	1.3	-	pF
T_{amb} = –40 °C to +85 °C						
V_{IH}	HIGH-level input voltage	V_{CC} = 0.8 V	0.70 × V_{CC}	-	-	V
		V_{CC} = 0.9 V to 1.95 V	0.65 × V_{CC}	-	-	V
		V_{CC} = 2.3 V to 2.7 V	1.6	-	-	V
		V_{CC} = 3.0 V to 3.6 V	2.0	-	-	V
V_{IL}	LOW-level input voltage	V_{CC} = 0.8 V	-	-	0.30 × V_{CC}	V
		V_{CC} = 0.9 V to 1.95 V	-	-	0.35 × V_{CC}	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	V
		V_{CC} = 3.0 V to 3.6 V	-	-	0.9	V

Table 7. Static characteristics *…continued*

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = -20\ \mu A$; $V_{CC} = 0.8\ V$ to $3.6\ V$		$V_{CC} - 0.1$	-	-	V
		$I_O = -1.1\ mA$; $V_{CC} = 1.1\ V$		$0.7 \times V_{CC}$	-	-	V
		$I_O = -1.7\ mA$; $V_{CC} = 1.4\ V$		1.03	-	-	V
		$I_O = -1.9\ mA$; $V_{CC} = 1.65\ V$		1.30	-	-	V
		$I_O = -2.3\ mA$; $V_{CC} = 2.3\ V$		1.97	-	-	V
		$I_O = -3.1\ mA$; $V_{CC} = 2.3\ V$		1.85	-	-	V
		$I_O = -2.7\ mA$; $V_{CC} = 3.0\ V$		2.67	-	-	V
		$I_O = -4.0\ mA$; $V_{CC} = 3.0\ V$		2.55	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}					
		$I_O = 20\ \mu A$; $V_{CC} = 0.8\ V$ to $3.6\ V$		-	-	0.1	V
		$I_O = 1.1\ mA$; $V_{CC} = 1.1\ V$		-	-	$0.3 \times V_{CC}$	V
		$I_O = 1.7\ mA$; $V_{CC} = 1.4\ V$		-	-	0.37	V
		$I_O = 1.9\ mA$; $V_{CC} = 1.65\ V$		-	-	0.35	V
		$I_O = 2.3\ mA$; $V_{CC} = 2.3\ V$		-	-	0.33	V
		$I_O = 3.1\ mA$; $V_{CC} = 2.3\ V$		-	-	0.45	V
		$I_O = 2.7\ mA$; $V_{CC} = 3.0\ V$		-	-	0.33	V
		$I_O = 4.0\ mA$; $V_{CC} = 3.0\ V$		-	-	0.45	V
I_I	input leakage current	$V_I = GND$ to $3.6\ V$; $V_{CC} = 0\ V$ to $3.6\ V$		-	-	±0.5	μA
I_{OFF}	power-off leakage current	V_I or $V_O = 0\ V$ to $3.6\ V$; $V_{CC} = 0\ V$		-	-	±0.5	μA
ΔI_{OFF}	additional power-off leakage current	V_I or $V_O = 0\ V$ to $3.6\ V$; $V_{CC} = 0\ V$ to $0.2\ V$		-	-	±0.6	μA
I_{CC}	supply current	$V_I = GND$ or V_{CC}; $I_O = 0\ A$; $V_{CC} = 0.8\ V$ to $3.6\ V$		-	-	0.9	μA
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 0.6\ V$; $I_O = 0\ A$; $V_{CC} = 3.3\ V$	[1]	-	-	50	μA
$T_{amb} = -40\ °C$ to $+125\ °C$							
V_{IH}	HIGH-level input voltage	$V_{CC} = 0.8\ V$		$0.75 \times V_{CC}$	-	-	V
		$V_{CC} = 0.9\ V$ to $1.95\ V$		$0.70 \times V_{CC}$	-	-	V
		$V_{CC} = 2.3\ V$ to $2.7\ V$		1.6	-	-	V
		$V_{CC} = 3.0\ V$ to $3.6\ V$		2.0	-	-	V
V_{IL}	LOW-level input voltage	$V_{CC} = 0.8\ V$		-	-	$0.25 \times V_{CC}$	V
		$V_{CC} = 0.9\ V$ to $1.95\ V$		-	-	$0.30 \times V_{CC}$	V
		$V_{CC} = 2.3\ V$ to $2.7\ V$		-	-	0.7	V
		$V_{CC} = 3.0\ V$ to $3.6\ V$		-	-	0.9	V

Table 7. Static characteristics *…continued*

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{OH}	HIGH-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = -20\ \mu A$; $V_{CC} = 0.8\ V$ to $3.6\ V$	$V_{CC} - 0.11$	-	-	V
		$I_O = -1.1\ mA$; $V_{CC} = 1.1\ V$	$0.6 \times V_{CC}$	-	-	V
		$I_O = -1.7\ mA$; $V_{CC} = 1.4\ V$	0.93	-	-	V
		$I_O = -1.9\ mA$; $V_{CC} = 1.65\ V$	1.17	-	-	V
		$I_O = -2.3\ mA$; $V_{CC} = 2.3\ V$	1.77	-	-	V
		$I_O = -3.1\ mA$; $V_{CC} = 2.3\ V$	1.67	-	-	V
		$I_O = -2.7\ mA$; $V_{CC} = 3.0\ V$	2.40	-	-	V
		$I_O = -4.0\ mA$; $V_{CC} = 3.0\ V$	2.30	-	-	V
V_{OL}	LOW-level output voltage	$V_I = V_{IH}$ or V_{IL}				
		$I_O = 20\ \mu A$; $V_{CC} = 0.8\ V$ to $3.6\ V$	-	-	0.11	V
		$I_O = 1.1\ mA$; $V_{CC} = 1.1\ V$	-	-	$0.33 \times V_{CC}$	V
		$I_O = 1.7\ mA$; $V_{CC} = 1.4\ V$	-	-	0.41	V
		$I_O = 1.9\ mA$; $V_{CC} = 1.65\ V$	-	-	0.39	V
		$I_O = 2.3\ mA$; $V_{CC} = 2.3\ V$	-	-	0.36	V
		$I_O = 3.1\ mA$; $V_{CC} = 2.3\ V$	-	-	0.50	V
		$I_O = 2.7\ mA$; $V_{CC} = 3.0\ V$	-	-	0.36	V
		$I_O = 4.0\ mA$; $V_{CC} = 3.0\ V$	-	-	0.50	V
I_I	input leakage current	$V_I = GND$ to $3.6\ V$; $V_{CC} = 0\ V$ to $3.6\ V$	-	-	±0.75	μA
I_{OFF}	power-off leakage current	V_I or $V_O = 0\ V$ to $3.6\ V$; $V_{CC} = 0\ V$	-	-	±0.75	μA
ΔI_{OFF}	additional power-off leakage current	V_I or $V_O = 0\ V$ to $3.6\ V$; $V_{CC} = 0\ V$ to $0.2\ V$	-	-	±0.75	μA
I_{CC}	supply current	$V_I = GND$ or V_{CC}; $I_O = 0\ A$; $V_{CC} = 0.8\ V$ to $3.6\ V$	-	-	1.4	μA
ΔI_{CC}	additional supply current	$V_I = V_{CC} - 0.6\ V$; $I_O = 0\ A$; $V_{CC} = 3.3\ V$ [1]	-	-	75	μA

[1] One input at $V_{CC} - 0.6\ V$, other input at V_{CC} or GND.

11. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Symbol	Parameter	Conditions	T_{amb} = 25 °C			T_{amb} = –40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 5 pF									
t_{pd}	propagation delay	I0, I1 to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	21.2	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.5	6.1	13.3	2.2	13.8	13.9	ns
		V_{CC} = 1.4 V to 1.6 V	1.9	4.2	7.8	2.0	8.4	8.8	ns
		V_{CC} = 1.65 V to 1.95 V	1.7	3.4	6.2	1.6	6.9	7.3	ns
		V_{CC} = 2.3 V to 2.7 V	1.5	2.7	4.3	1.2	4.9	5.2	ns
		V_{CC} = 3.0 V to 3.6 V	1.3	2.4	3.7	1.0	4.0	4.2	ns
		S to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	23.6	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.6	6.6	13.8	2.2	14.3	14.5	ns
		V_{CC} = 1.4 V to 1.6 V	1.9	4.5	8.0	2.1	8.7	9.1	ns
		V_{CC} = 1.65 V to 1.95 V	1.7	3.6	6.3	1.6	7.0	7.4	ns
		V_{CC} = 2.3 V to 2.7 V	1.6	2.8	4.4	1.2	5.0	5.3	ns
		V_{CC} = 3.0 V to 3.6 V	1.3	2.5	3.7	1.0	4.0	4.2	ns
		$\overline{E}$ to Y, $\overline{Y}$; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	22.6	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	2.7	6.4	13.7	2.5	14.3	14.5	ns
		V_{CC} = 1.4 V to 1.6 V	2.1	4.4	8.0	2.1	8.7	9.1	ns
		V_{CC} = 1.65 V to 1.95 V	1.8	3.6	6.3	1.6	7.0	7.4	ns
		V_{CC} = 2.3 V to 2.7 V	1.6	2.8	4.2	1.4	4.8	5.1	ns
		V_{CC} = 3.0 V to 3.6 V	1.4	2.5	3.6	1.1	3.9	4.2	ns

Table 8. Dynamic characteristics *...continued*

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Symbol	Parameter	Conditions		T_{amb} = 25 °C			T_{amb} = –40 °C to +125 °C			Unit
				Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 10 pF										
t_{pd}	propagation delay	I0, I1 to Y, $\overline{Y}$; see Figure 9	[2]							
		V_{CC} = 0.8 V		-	24.5	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		2.9	6.9	15.1	2.5	15.6	15.8	ns
		V_{CC} = 1.4 V to 1.6 V		2.2	4.8	8.9	2.4	9.6	10.0	ns
		V_{CC} = 1.65 V to 1.95 V		2.1	4.0	7.1	1.9	7.9	8.3	ns
		V_{CC} = 2.3 V to 2.7 V		1.9	3.2	5.0	1.6	5.7	6.0	ns
		V_{CC} = 3.0 V to 3.6 V		1.7	2.9	4.4	1.3	4.7	5.0	ns
		S to Y, $\overline{Y}$; see Figure 9	[2]							
		V_{CC} = 0.8 V		-	27.2	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.0	7.4	15.5	2.6	16.1	16.4	ns
		V_{CC} = 1.4 V to 1.6 V		2.3	5.1	9.0	2.4	9.8	10.3	ns
		V_{CC} = 1.65 V to 1.95 V		2.1	4.2	7.2	1.9	8.0	8.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.9	3.4	5.1	1.6	5.7	6.1	ns
		V_{CC} = 3.0 V to 3.6 V		1.7	3.0	4.4	1.4	4.7	5.0	ns
		$\overline{E}$ to Y, $\overline{Y}$; see Figure 10	[2]							
		V_{CC} = 0.8 V		-	25.9	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V		3.1	7.2	15.5	2.8	16.1	16.4	ns
		V_{CC} = 1.4 V to 1.6 V		2.5	5.0	9.0	2.4	9.8	10.3	ns
		V_{CC} = 1.65 V to 1.95 V		2.2	4.1	7.1	1.9	8.0	8.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.9	3.3	4.9	1.7	5.5	5.9	ns
		V_{CC} = 3.0 V to 3.6 V		1.7	3.0	4.2	1.5	4.6	4.8	ns

Table 8. Dynamic characteristics *...continued*

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Symbol	Parameter	Conditions	T_{amb} = 25 °C			T_{amb} = –40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 15 pF									
t_{pd}	propagation delay	I0, I1 to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	27.8	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.3	7.7	16.8	2.8	17.4	17.6	ns
		V_{CC} = 1.4 V to 1.6 V	2.5	5.4	9.8	2.7	10.6	11.2	ns
		V_{CC} = 1.65 V to 1.95 V	2.4	4.4	7.8	2.2	8.7	9.2	ns
		V_{CC} = 2.3 V to 2.7 V	2.2	3.7	5.6	1.9	6.4	6.7	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	3.4	4.9	1.6	5.3	5.6	ns
		S to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	30.7	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.3	8.2	17.2	2.9	17.9	18.2	ns
		V_{CC} = 1.4 V to 1.6 V	2.6	5.7	10.0	2.7	10.9	11.4	ns
		V_{CC} = 1.65 V to 1.95 V	2.4	4.7	7.9	2.2	8.9	9.4	ns
		V_{CC} = 2.3 V to 2.7 V	2.2	3.8	5.7	1.9	6.5	6.8	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	3.5	5.0	1.6	5.4	5.7	ns
		$\overline{E}$ to Y, $\overline{Y}$; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	29.1	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	3.5	8.0	17.2	3.1	17.9	18.2	ns
		V_{CC} = 1.4 V to 1.6 V	2.8	5.6	9.9	2.7	10.9	11.4	ns
		V_{CC} = 1.65 V to 1.95 V	2.4	4.6	7.9	2.2	8.9	9.4	ns
		V_{CC} = 2.3 V to 2.7 V	2.2	3.8	5.5	2.0	6.2	6.6	ns
		V_{CC} = 3.0 V to 3.6 V	2.0	3.4	4.7	1.8	5.1	5.4	ns

Table 8. Dynamic characteristics *...continued*

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

Symbol	Parameter	Conditions	T_{amb} = 25 °C			T_{amb} = –40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 30 pF									
t_{pd}	propagation delay	I0, I1 to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	35.4	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	4.3	9.8	21.6	3.7	22.5	22.8	ns
		V_{CC} = 1.4 V to 1.6 V	3.3	6.9	12.4	3.4	13.6	14.4	ns
		V_{CC} = 1.65 V to 1.95 V	3.1	5.7	10.0	2.8	11.3	11.9	ns
		V_{CC} = 2.3 V to 2.7 V	2.9	4.8	7.2	2.6	8.2	8.7	ns
		V_{CC} = 3.0 V to 3.6 V	2.8	4.4	6.4	2.3	6.9	7.3	ns
		S to Y, $\overline{Y}$; see Figure 9 [2]							
		V_{CC} = 0.8 V	-	38.8	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	4.4	10.5	22.0	3.7	23.0	23.4	ns
		V_{CC} = 1.4 V to 1.6 V	3.3	7.2	12.6	3.5	13.9	14.6	ns
		V_{CC} = 1.65 V to 1.95 V	3.1	5.9	10.1	2.8	11.4	12.0	ns
		V_{CC} = 2.3 V to 2.7 V	2.9	4.9	7.3	2.6	8.3	8.7	ns
		V_{CC} = 3.0 V to 3.6 V	2.7	4.5	6.4	2.3	6.9	7.3	ns
		$\overline{E}$ to Y, $\overline{Y}$; see Figure 10 [2]							
		V_{CC} = 0.8 V	-	36.8	-	-	-	-	ns
		V_{CC} = 1.1 V to 1.3 V	4.4	10.1	22.1	3.9	23.0	23.4	ns
		V_{CC} = 1.4 V to 1.6 V	3.6	7.1	12.6	3.5	13.8	14.6	ns
		V_{CC} = 1.65 V to 1.95 V	3.1	5.8	10.0	2.8	11.3	12.0	ns
		V_{CC} = 2.3 V to 2.7 V	2.9	4.9	7.1	2.7	8.0	8.5	ns
		V_{CC} = 3.0 V to 3.6 V	2.7	4.5	6.2	2.4	6.7	7.0	ns

Table 8. Dynamic characteristics *...continued*

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 11.

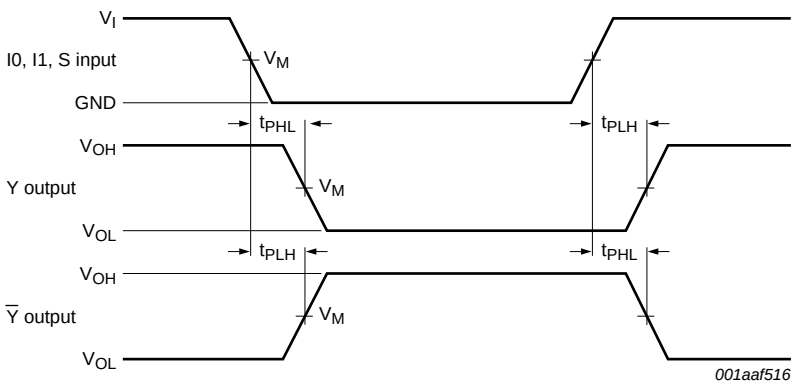
Symbol	Parameter	Conditions	T_{amb} = 25 °C			T_{amb} = –40 °C to +125 °C			Unit
			Min	Typ[1]	Max	Min	Max (85 °C)	Max (125 °C)	
C_L = 5 pF, 10 pF, 15 pF and 30 pF									
C_{PD}	power dissipation capacitance	f_i = 1 MHz; V_I = GND to V_{CC} [3]							
		V_{CC} = 0.8 V	-	5.2	-	-	-	-	pF
		V_{CC} = 1.1 V to 1.3 V	-	5.5	-	-	-	-	pF
		V_{CC} = 1.4 V to 1.6 V	-	5.7	-	-	-	-	pF
		V_{CC} = 1.65 V to 1.95 V	-	6.0	-	-	-	-	pF
		V_{CC} = 2.3 V to 2.7 V	-	6.9	-	-	-	-	pF
		V_{CC} = 3.0 V to 3.6 V	-	7.9	-	-	-	-	pF

[1] All typical values are measured at nominal V_{CC}.

[2] t_{pd} is the same as t_{PLH} and t_{PHL}

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).
$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:
f_i = input frequency in MHz;
f_o = output frequency in MHz;
C_L = output load capacitance in pF;
V_{CC} = supply voltage in V;
N = number of inputs switching;
$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

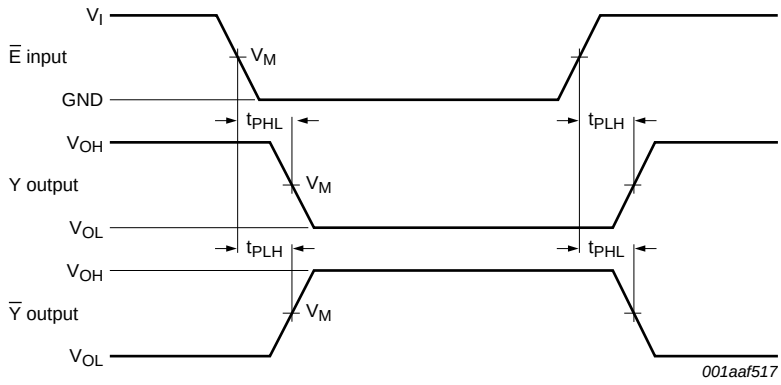
12. Waveforms



Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 9. The data inputs (I0, I1) and data select input (S) to output (Y, $\overline{Y}$) propagation delays



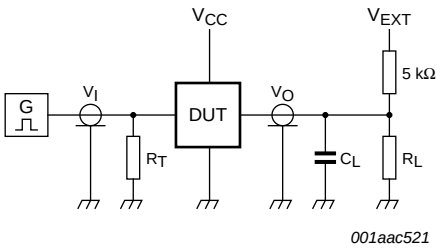
Measurement points are given in Table 9.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 10. The enable input ($\overline{E}$) to output (Y, $\overline{Y}$) propagation delays

Table 9. Measurement points

Supply voltage	Output	Input		
V_{CC}	V_M	V_M	V_I	$t_r = t_f$
0.8 V to 3.6 V	0.5 × V_{CC}	0.5 × V_{CC}	V_{CC}	≤ 3.0 ns



Test data is given in Table 10.

Definitions for test circuit:

R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

R_T = Termination resistance should be equal to the output impedance Z_o of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 11. Test circuit for measuring switching times

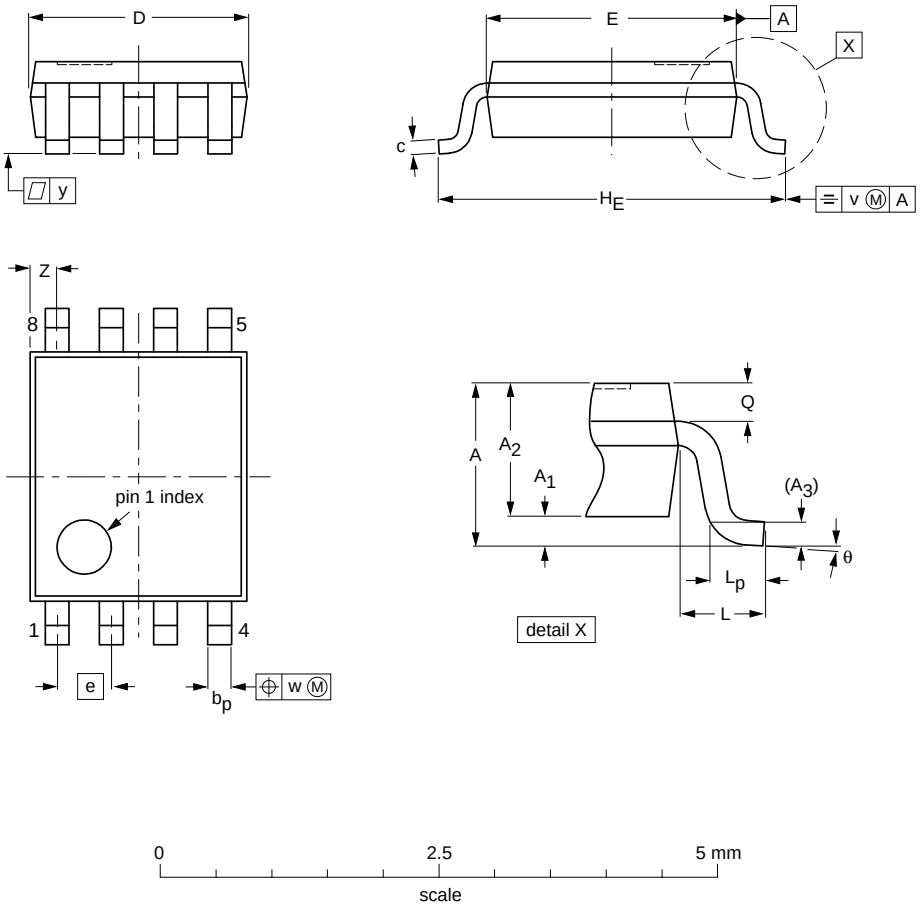
Table 10. Test data

Supply voltage	Load		V_{EXT}		
V_{CC}	C_L	R_L[1]	t_{PLH}, t_{PHL}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
0.8 V to 3.6 V	5 pF, 10 pF, 15 pF and 30 pF	5 kΩ or 1 MΩ	open	GND	2 × V_{CC}

[1] For measuring enable and disable times R_L = 5 kΩ, for measuring propagation delays, setup and hold times and pulse width R_L = 1 MΩ.

13. Package outline

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm **SOT765-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(2)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	1	0.15 0.00	0.85 0.60	0.12	0.27 0.17	0.23 0.08	2.1 1.9	2.4 2.2	0.5	3.2 3.0	0.4	0.40 0.15	0.21 0.19	0.2	0.13	0.1	0.4 0.1	8° 0°

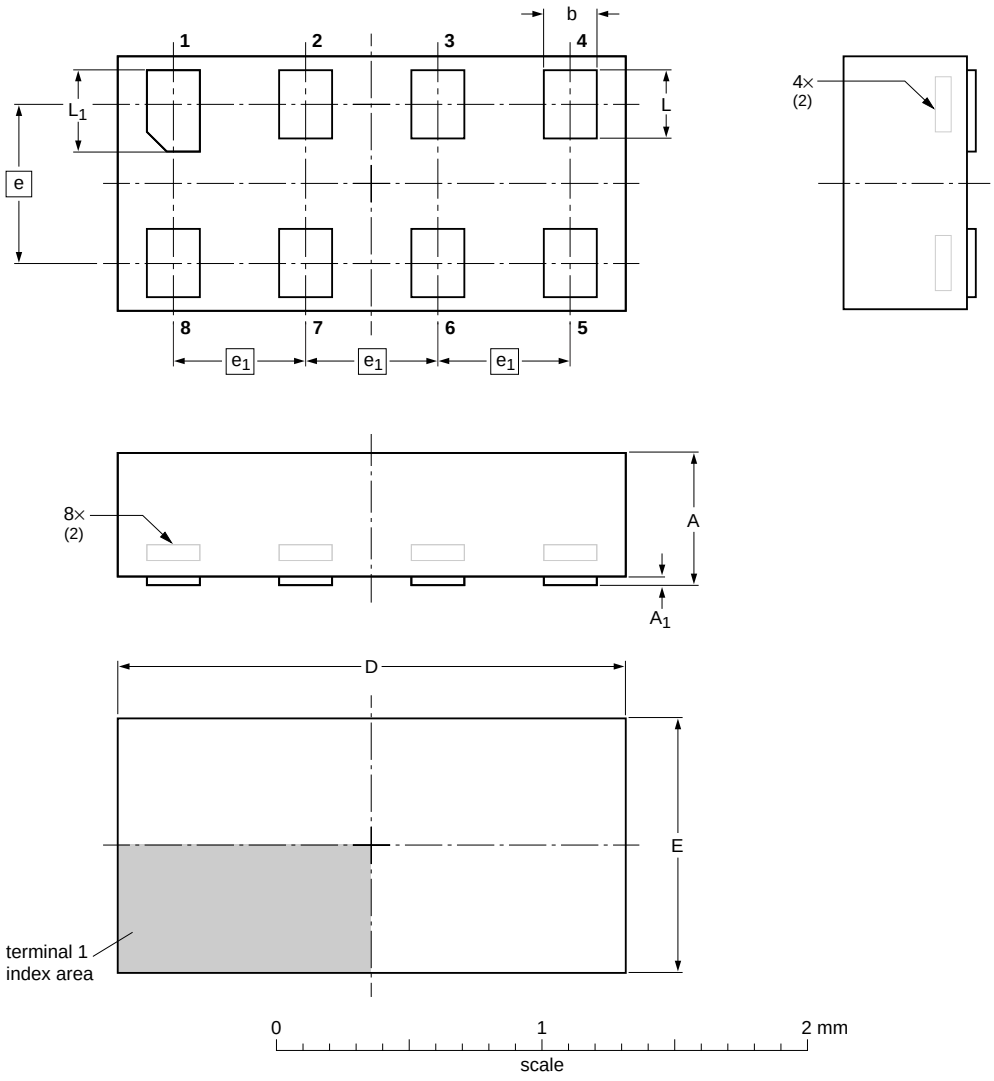
Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT765-1		MO-187				02-06-07

Fig 12. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm **SOT833-1**



DIMENSIONS (mm are the original dimensions)

UNIT	A(1) max	A1 max	b	D	E	e	e1	L	L1
mm	0.5	0.04	0.25 0.17	2.0 1.9	1.05 0.95	0.6	0.5	0.35 0.27	0.40 0.32

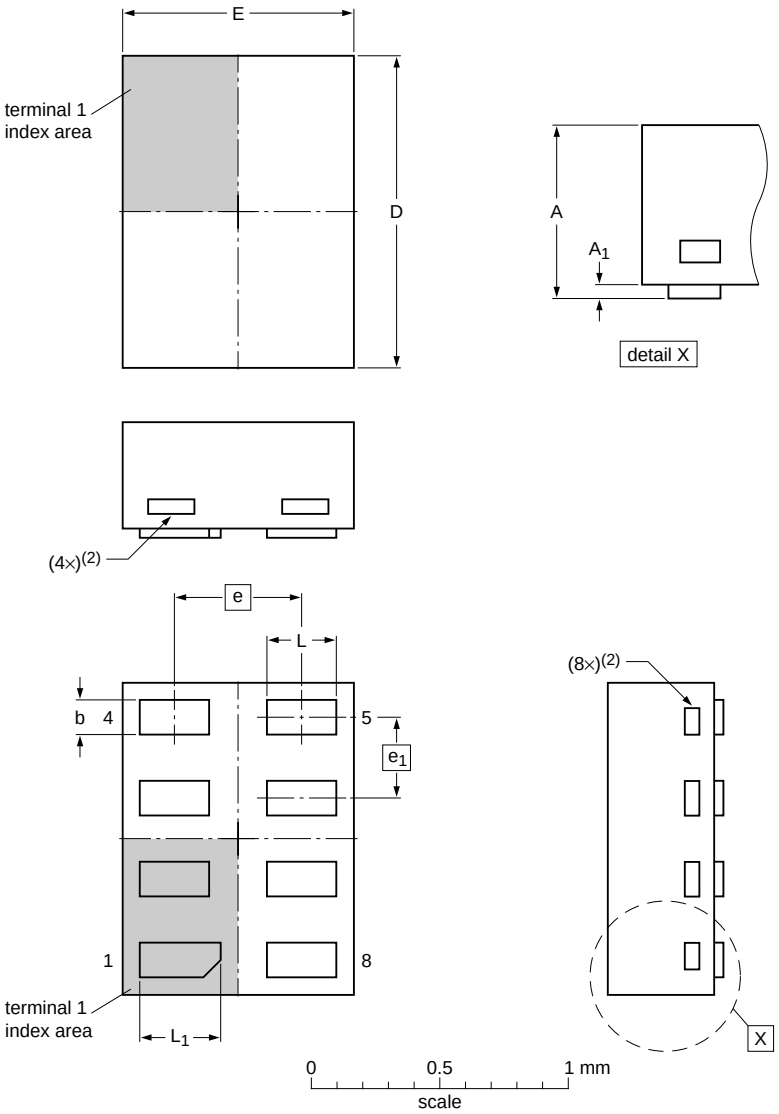
Notes

1. Including plating thickness.
2. Can be visible in some manufacturing processes.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT833-1	- - -	MO-252	- - -			~~07-11-14~~ 07-12-07

Fig 13. Package outline SOT833-1 (XSON8)

XSON8: extremely thin small outline package; no leads; 8 terminals; body 1.35 x 1 x 0.5 mm **SOT1089**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.5	0.04	0.20	1.40	1.05			0.35	0.40
	nom			0.15	1.35	1.00	0.55	0.35	0.30	0.35
	min			0.12	1.30	0.95			0.27	0.32

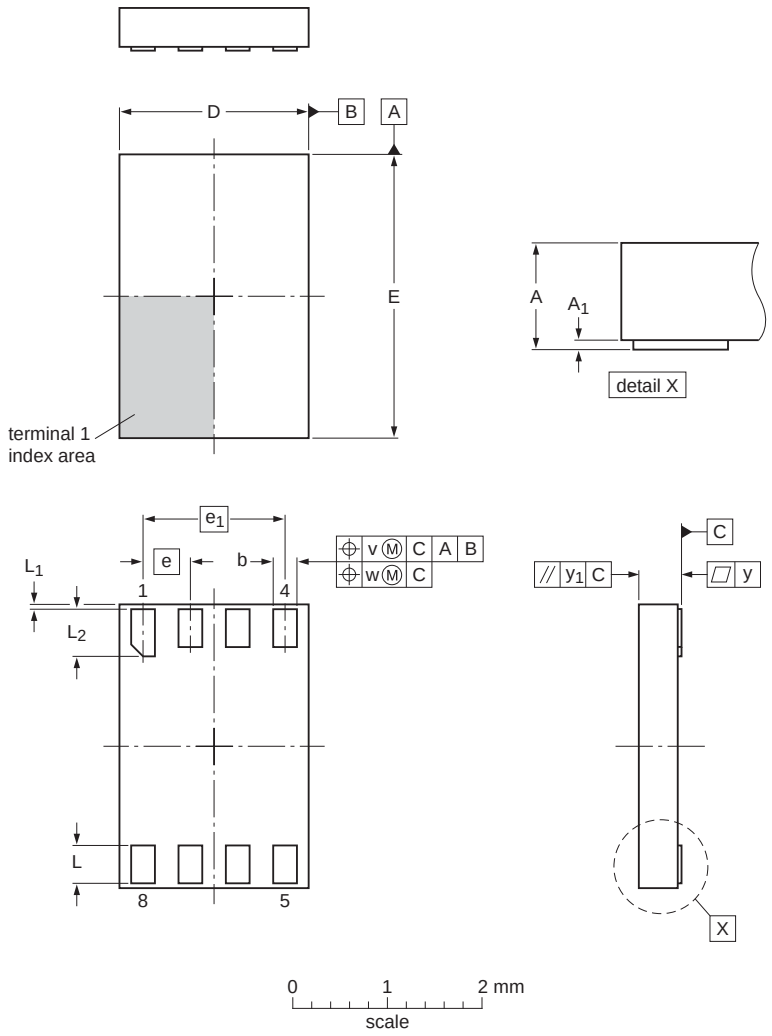
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1089_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1089		MO-252				~~10-04-09~~ 10-04-12

Fig 14. Package outline SOT1089 (XSON8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 3 x 2 x 0.5 mm **SOT996-2**



Dimensions (mm are the original dimensions)

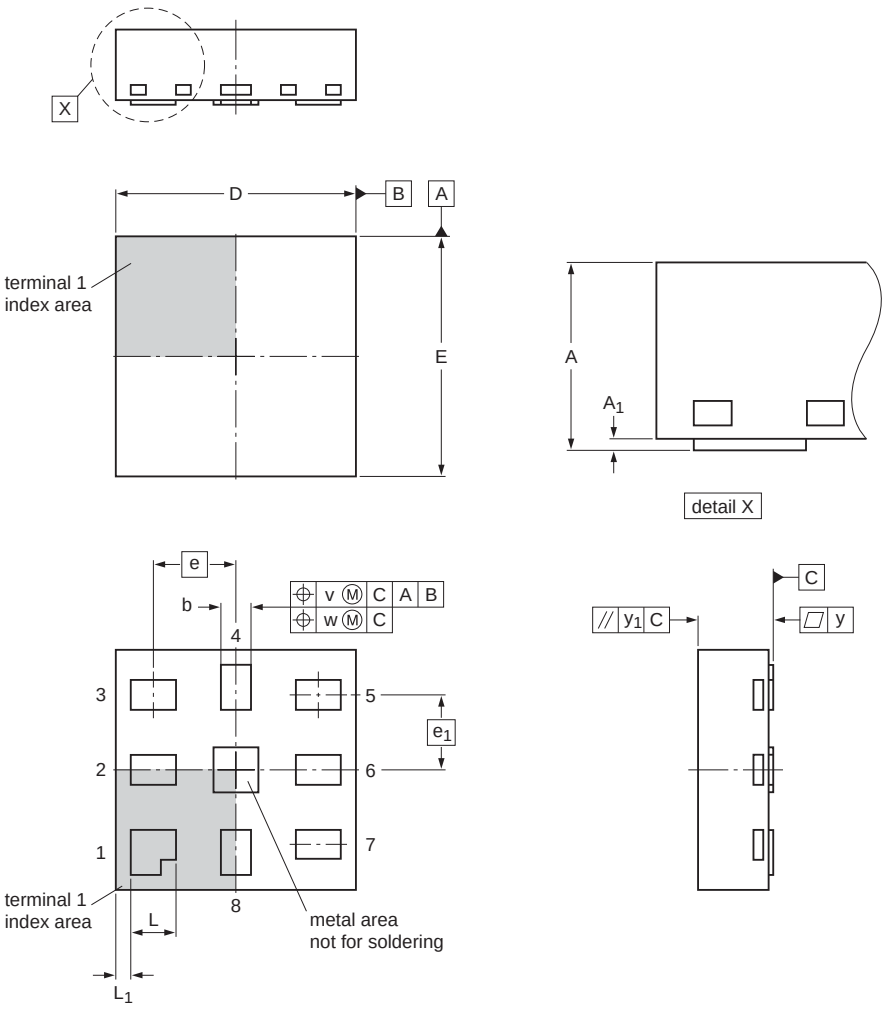
Unit[1]		A	A_1	b	D	E	e	e_1	L	L_1	L_2	v	w	y	y_1
mm	max	0.5	0.05	0.35	2.1	3.1	0.5	1.5	0.5	0.15	0.6	0.1	0.05	0.05	0.1
	nom														
	min		0.00	0.15	1.9	2.9			0.3	0.05	0.4				

sot996-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT996-2						~~07-12-21~~ 12-11-20

Fig 15. Package outline SOT996-2 (XSON8)

XQFN8: plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 x 1.6 x 0.5 mm **SOT902-2**



Dimensions

Unit(1)		A	A_1	b	D	E	e	e_1	L	L_1	v	w	y	y_1
mm	max	0.5	0.05	0.25	1.65	1.65			0.35	0.15				
	nom			0.20	1.60	1.60	0.55	0.5	0.30	0.10	0.1	0.05	0.05	0.05
	min		0.00	0.15	1.55	1.55			0.25	0.05				

Note

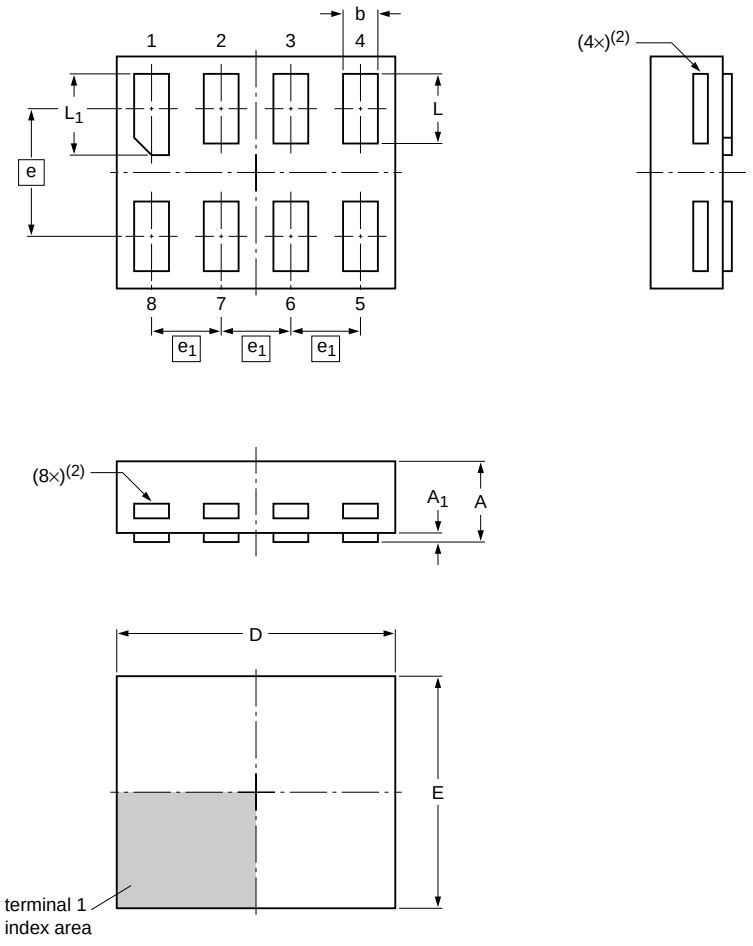
1. Plastic or metal protrusions of 0.075 mm maximum per side are not included.

sot902-2_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT902-2	- - -	MO-255	- - -			~~10-11-02~~ 11-03-31

Fig 16. Package outline SOT902-2 (XQFN8)

XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.2 x 1.0 x 0.35 mm **SOT1116**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	1.25	1.05			0.35	0.40
	nom			0.15	1.20	1.00	0.55	0.3	0.30	0.35
	min			0.12	1.15	0.95			0.27	0.32

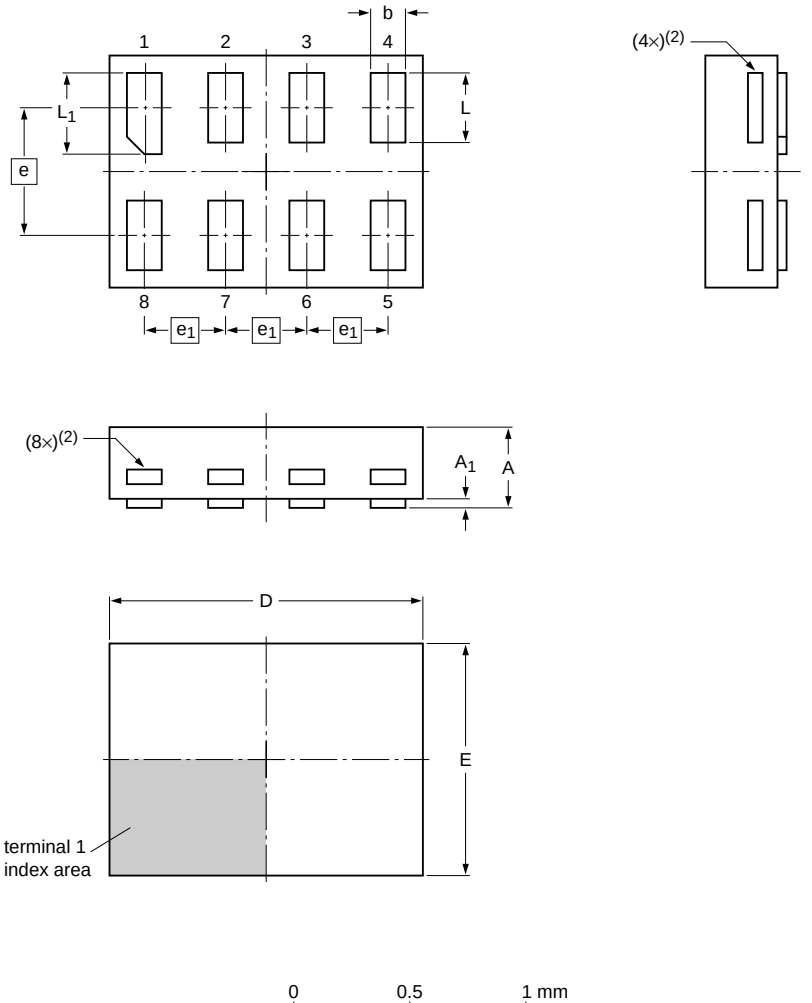
Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1116_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1116						~~10-04-02~~ 10-04-07

Fig 17. Package outline SOT1116 (XSON8)

XSON8: extremely thin small outline package; no leads;
8 terminals; body 1.35 x 1.0 x 0.35 mm **SOT1203**



Dimensions

Unit		$A^{(1)}$	A_1	b	D	E	e	e_1	L	L_1
mm	max	0.35	0.04	0.20	1.40	1.05			0.35	0.40
	nom			0.15	1.35	1.00	0.55	0.35	0.30	0.35
	min			0.12	1.30	0.95			0.27	0.32

Note
1. Including plating thickness.
2. Visible depending upon used manufacturing technology.

sot1203_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1203						~~10-04-02~~ 10-04-06

Fig 18. Package outline SOT1203 (XSON8)

14. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MM	Machine Model

15. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74AUP2G157 v.7	20130118	Product data sheet	-	74AUP2G157 v.6
Modifications:	• For type number 74AUP2G157GD XSON8U has changed to XSON8.			
74AUP2G157 v.6	20120606	Product data sheet	-	74AUP2G157 v.5
74AUP2G157 v.5	20111205	Product data sheet	-	74AUP2G157 v.4
74AUP2G157 v.4	20100730	Product data sheet	-	74AUP2G157 v.3
74AUP2G157 v.3	20080702	Product data sheet	-	74AUP2G157 v.2
74AUP2G157 v.2	20080219	Product data sheet	-	74AUP2G157 v.1
74AUP2G157 v.1	20061006	Product data sheet	-	-

16. Legal information

16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

16.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. Nexperia does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local Nexperia sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between Nexperia and its customer, unless Nexperia and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the Nexperia product is deemed to offer functions and qualities beyond those described in the Product data sheet.

16.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, Nexperia does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. Nexperia takes no responsibility for the content in this document if provided by an information source outside of Nexperia.

In no event shall Nexperia be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, Nexperia's aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of Nexperia.

Right to make changes — Nexperia reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — Nexperia products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of a Nexperia product can reasonably be expected to result in personal injury, death or severe property or environmental damage. Nexperia and its suppliers accept no liability for inclusion and/or use of Nexperia products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. Nexperia makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using Nexperia products, and Nexperia accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the Nexperia product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

Nexperia does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using Nexperia products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). Nexperia does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — Nexperia products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nexperia.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. Nexperia hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of Nexperia products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific Nexperia product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. Nexperia accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without Nexperia's warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond Nexperia's specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies Nexperia for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond Nexperia's standard warranty and Nexperia's product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

16.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

17. Contact information

For more information, please visit: **http://www.nexperia.com**

For sales office addresses, please send an email to: **salesaddresses@nexperia.com**

18. Contents

For more information, please visit: http://www.nexperia.com
For sales office addresses, please send an email to: salesaddresses@nexperia.com
Date of release: 18 January 2013

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Encoders, Decoders, Multiplexers & Demultiplexers ***category:***

Click to view products by NXP ***manufacturer:***

Other Similar products are found below :

M38510/01406BEA MC74HC163ADTG 74HC253N HMC854LC5TR NLV74VHC1G01DFT1G NLVHC4851ADTR2G NLVHCT4851ADTR2G PI3B33X257BE M74HCT4052ADTR2G M74VHC1GT04DFT3G TC74AC138P(F) MC74LVX4051MNTWG HMC855LC5TR NLV14028BDR2G NLV14051BDR2G NLV74HC238ADTR2G 715428X COMX-CAR-210 5962-8607001EA 5962-8756601EA MAX3783UCM+D PI5C3253QEX 8CA3052APGGI8 TC74HC4051AF(EL,F) TC74VHC138F(EL,K,F PI3B3251LE PI5C3309UEX PI5C3251QEX PI3B3251QE 74VHC4052AFT(BJ) PI3PCIE3415AZHEX NLV74HC4851AMNTWG MC74LVX257DG M74HC151YRM13TR M74HC151YTTR PI5USB31213XEAEX M74HCT4851ADWR2G XD74LS154 AP4373AW5-7-01 QS3VH251QG8 QS4A201QG HCS301T-ISN HCS500-I/SM MC74HC151ADTG TC4066BP(N,F) 74ACT11139PWR HMC728LC3CTR 74VHC238FT(BJ) 74VHC4066AFT(BJ) 74VHCT138AFT(BJ)